SPECIFICATION FOR LCD MODULE

Model No. TM13264ECAG

Prepared by:	Date:
Checked by :	Date:
Verified by :	Date:
Approved by:	Date:

TIANMA MICROELECTRONICS CO., LED

REVISION RECORD

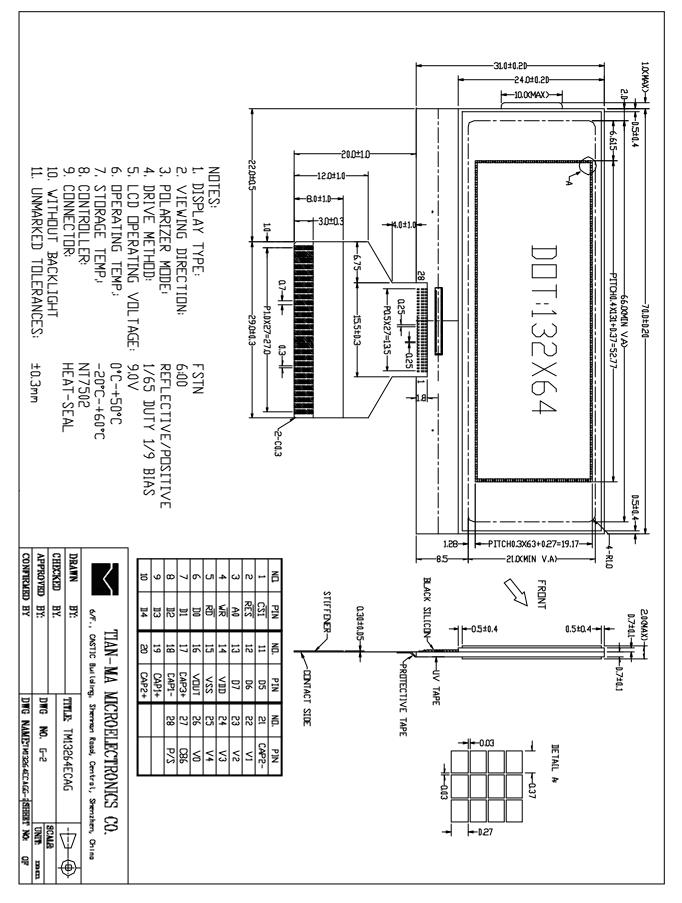
Date	Ref. Page	Revision No.	Revision Items	Check & Approval

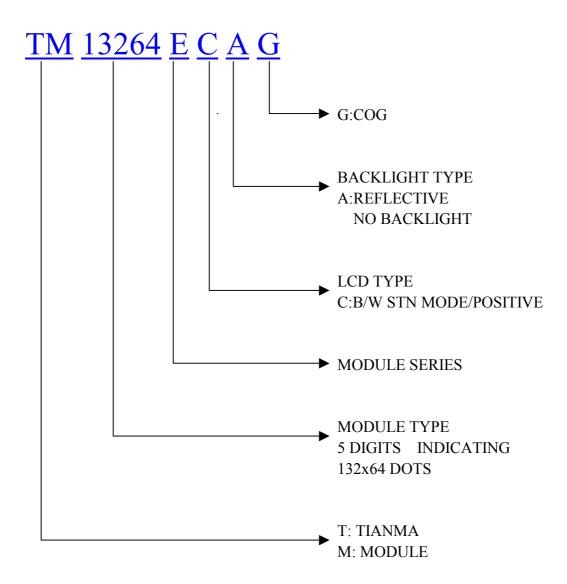
1. General Specifications:

1.1 Display type:	STN/B-W
1.2 Display color*:	
Display color:	Blue-Black
Background:	White
1.3 Polarizer mode:	Reflective/Positive
1.4 Viewing Angle:	6:00
1.5 Driving Method:	1/65Duty 1/9 Bias
1.6 Without Backligh	t
1.7 Operating Temp	erature: 0+50°C
Storage Temper	rature: -20+60°C
1.8 Outline Dimensio	ons: Refer to outline drawing on next page
1.9 Dot Matrix:	132 X64
1.10 Dot Size:	0.37X0.27(mm)
1.11 Dot Pitch:	0.40X0.30 (mm)
1.12 Weight:	20g

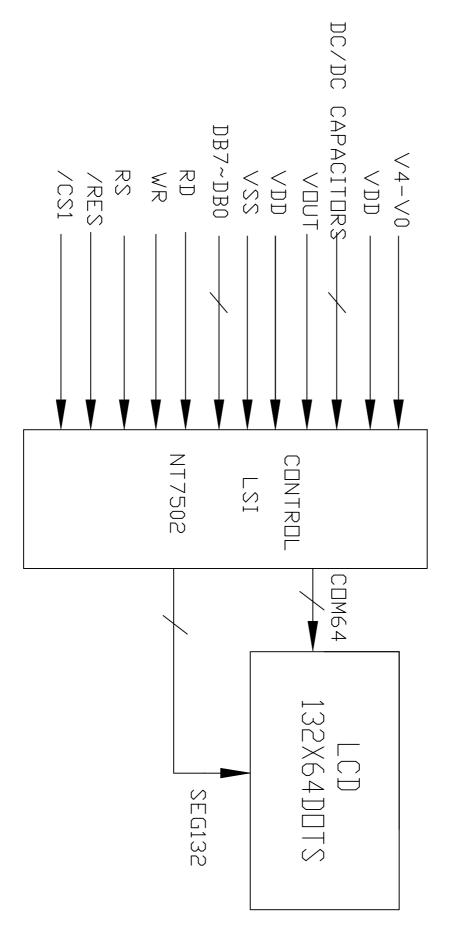
* Color tone is slightly changed by temperature and driving voltage.

2 Outline Drawing





4 Circuit Block Diagram



5 Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	Vdd-Vss	2.4	3.5	v	
LCD Driving Voltage	VLCD	4.5	11.5	v	
Operating Temperature Range	Тор	0	+50	Ċ	No
Storage Temperature Range	Тѕт	-20	+60)	Condensation

6 Electrical Specifications and Instruction Code

6.1 Electrical characteristics

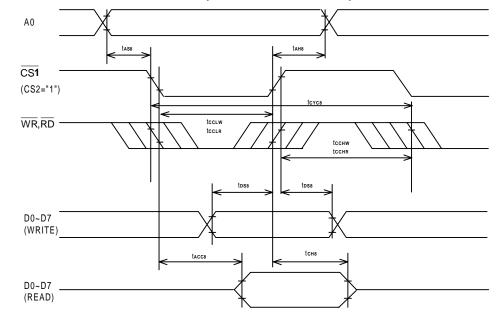
Iter	n	Symbol	Min.	Тур.	Max.	Unit
Supply V (Log	-	Vdd- Vss	2.4	2.85	3.5	V
Supply V (LCD E	-	Vlcd	-	9.0	-	v
Input	High	V _{ін} (V _{DD} =3.0)	$0.8 V_{DD}$	-	V _{DD} +0.3	v
Signal Voltage	Low	V _{IL} (V _{DD} =3.0)	0	-	$0.2 \ V_{DD}$	V
Supply c (Log		I _{DD} (V _{DD} - V _{SS} =3.0V)	-	-	160	uA

6.2 Interface Signals

Pin No.	Symbol	Level	Description			
1	CS1B	H/L	Chip select signal			
2	RES	H/L	Reset signal input			
3	A 0	H/L	Instruction/Data select			
4	WR	H/L	Read/Write control signal			
5	RD	H/L	Chip enable signal			
6	D0	H/L	Data bits 0			
7	D1	H/L	Data bits 1			
8	D2	H/L	Data bits 2			
9	D3	H/L	Data bits 3			
10	D4	H/L	Data bits 4			
11	D5	H/L	Data bits 5			
12	D6	H/L	Data bits 6			
13	D7	H/L	Data bits 7			
14	VDD	2.85V	Power supply voltage for logic			
15	VSS	0V	Ground			
16	VOUT	-	DC/DC voltage converter output			
17	CAP3+	-	Capacitor pin for voltage converter			
18	CAP1-	-	Capacitor pin for voltage converter			
19	CAP1+	-	Capacitor pin for voltage converter			
20	CAP2+	I	Capacitor pin for voltage converter			
21	CAP2-	-	Capacitor pin for voltage converter			
22	V1	-	Power supply voltage for LCD			
23	V2	-	Power supply voltage for LCD			
24	V3	-	Power supply voltage for LCD			
25	V4	-	Power supply voltage for LCD			
26	V 0	9.0V	Power supply voltage for LCD			
27	C86	-	MPU Interface switch terminal			
28	P/S	-	Parallel data input/serial data input switch terminal			

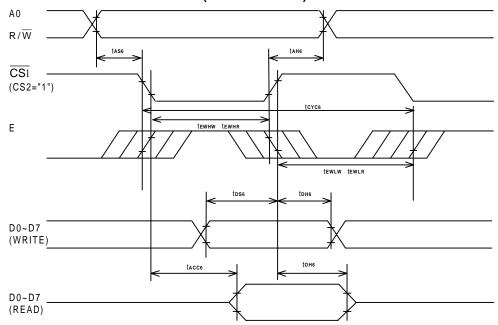
6.3 Interface Timing Chart

AC Characteristics



(1) System buses Read/Write characteristics 1 (For the 8080 Series MPU)

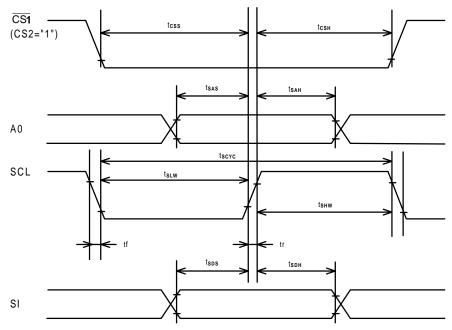
						$(VDD=2.7 - 3.3V, Ta = -40 - 85^{\circ}C)$
Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
Тан8	Address hold time	0			ns	
TAS8	Address setup time	0			ns	
Тсүс8	System cycle time	300			ns	
TCCLW	Control L pulse width (WR)	60			ns	
TCCLR	Control L pulse width (RD)	120			ns	
Тсснw	Control H pulse width (WR)	60			ns	
TCCHR	Control H pulse width (RD)	60			ns	
Tds8	Data setup time	40			ns	
7Тдн8	Data hold time	15			ns	
TACC8	RD access time			140	ns	CL=100pF
Тснв	Output disable time	10		100	ns	CL=100pF



(2) System buses Read/Write Characteristics 2 (6800 Series MPU)

						$(VDD=2.7 - 3.3V, TA = -40 - 85^{\circ}C)$
Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
Тсүс6	System cycle time	300			nS	
Tas6	Address setup time	0			nS	
Тан6	Address hold time	0			nS	
TDS6	Data setup time	40			nS	
TDH6	Data hold time	15			nS	
Тон6	Output disable time	10		100	nS	CL=100pF
TACC6	Access time			140	nS	CL=100pF
Tewhr	Enable H pulse width (Read)	120			nS	
Темнм	Enable H pulse width (Write)	60			nS	
Tewlr	Enable L pulse width (Read)	60			nS	
TEWLW	Enable L pulse width (Write)	60			nS	

(3) Serial interface



 $(VDD=2.7 - 3.3V, Ta = -40 - 85^{\circ}C)$

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
Тѕсүс	Serial clock cycle	250			nS	
Тsнw	Serial clock H pulse width	100			nS	
Tslw	Serial clock L pulse width	100			nS	
Tsas	Address setup time	150			nS	
Тѕан	Address hold time	150			nS	
Tsds	Data setup time	100			nS	
TSDH	Data hole time	100			nS	
Tcss	cs serial clock time	150			nS	
Тсѕн	cs serial clock time	150			nS	

							Code	•					
	Command	A0	RD	\overline{WR}	D7	D6	D5	D4	D3	D2	D1	D0	Function
(1)	Display ON/OFF	0	1	0	1	0	1	0	1	1	1	D	Turns on LCD panel when goes high, and turns off when goes low
(2)	Set Display Start Line	0	1	0	0	1	Displa	ay star	t addre	ess			Specifies RAM display line for COM0
(3)	Set Page Address	0	1	0	1	0	1	1	Page	addre	SS		Sets the display RAM page in Page Address register
(4)	Set Column Address 4 higher bits	0	1	0	0	0	0	1	Highe	er colu	mn ado	dress	Sets 4 higher bits of column address of display RAM in register
(4)	Set column Address 4 lower bits	0	1	0	0	0	0	0	Lowe	r colun	nn add	ress	Sets 4 lower bits of column address of display RAM in register
(5)	Read Status	0	0	1	Status	6			0	0	0	0	Reads the status information
(6)	Write Display Data	1	1	0	Write	data							Writes data in display RAM
(7)	Read Display Data	1	0	1	Read	data							Reads data from display RAM
(8)	ADC select	0	1	0	1	0	1	0	0	0	0	D	Sets the display RAM address SEG output correspondence
(9)	Normal/Reverse Display	0	1	0	1	0	1	0	0	1	1	D	Normal indication when low, but full indication when high
(10)	Entire Display ON/OFF	0	1	0	1	0	1	0	0	1	0	0 1	Selects normal display (0) or Entire Display ON (1)
(11)	Set LCD Bias	0	1	0	1	0	1	0	0	0	1	D	Sets LCD drive voltage bias ratio
(12)	Read-Modify-Write	0	1	0	1	1	1	0	0	0	0	0	Increments Column Address counter during each write
(13)	End	0	1	0	1	1	1	0	1	1	1	0	Releases the Read-Modify- Write
(14)	Reset	0	1	0	1	1	1	0	0	0	1	0	Resets internal functions
(15)	Common output mode select	0	1	0	1	1	0	0	D	*	*	*	Selects COM output scan direction. * Invalid data
(16)	Set Power Control	0	1	0	0	0	1	0	1	Ope	ration	status	Selects the power circuit operation mode
(17)	V0 voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Re	sistor	ratio	Select internal resistor ratio (Rb / Ra) mode
(18)	Electronic volume mode set	0	1	0	1	0	0	0	0	0	0	1	
	Electronic Volume Register set	0	1	0	*	*		Elec	tronic	control	value		Set the V0 output voltage electronic volume register
(19)	Set static indicator On/Off	0	1	0	1	0	1	0	1	1	0	D	Set static indicator On/Off 0: OFF 1: ON
	Set Static indicator register	0	1	0	*	*	*	*	*				Set the flashing mode
(20)	Power Save	-	-	-	-	-	-	-	-	-	-	-	Compound command of display OFF and entire display ON
(21)	NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation
(22)	Test Command	0	1	0	1	1	1	1	*	*	*	*	IC Test command. Do not use!
(23)	Test Mode Reset	0	1	0	1	1	1	1	0	0	0	0	Command of test mode reset

Note: Do not use any other command, or the system malfunction may result.

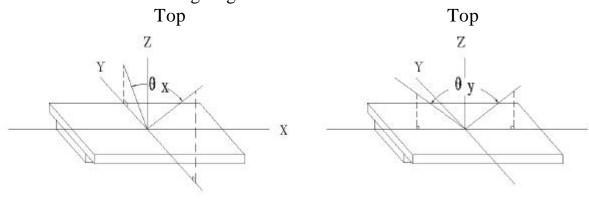
7 Optical Characteristics

7.1 Optical Characteristics

Ta=25℃ Condition Тур. Item Symbol Min. Max. Unit $\theta_{\rm X}$ $\theta_{y}=0^{\circ}$ -30 20 ___ Viewing Angle Cr 2 Deg $\theta_{x=0}^{\circ}$ θy -30 30 -- $\theta_{x=0}^{\circ}$ **Contrast Ratio** Cr 3.0 -- $\theta_{y=0}^{\circ}$ Turn Ton 300 -on $\theta_{x=0}^{\circ}$ Response ms $\theta_{y=0}^{\circ}$ Time Turn Toff 300 -off

7.2 Definition of Optical Characteristics

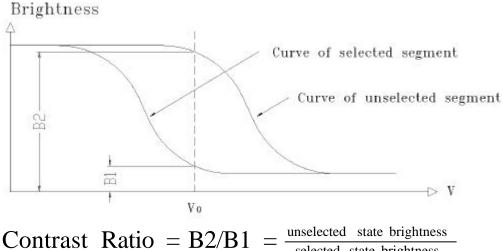
7.2.1 Definition of Viewing Angle



Bottom 7.2.2 Definition of Contrast Ratio



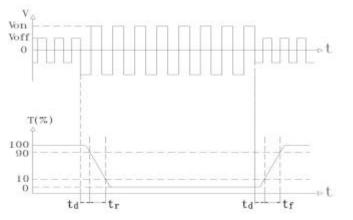
X



Measuring Conditions: D2/D1 - selected state brightness

2) Frame frequency: 64Hz

1) Ambient Temperature: 25° ; 7.2.3 Definition of Response time



Turn on time: $t_{on} = t_d + t_r$ Turn off time: $t_{off} = t_d + t_f$ Measuring Condition:

1) Operating Voltage: 9.0V 2) Frame frequency: 64Hz

8 Reliability

8.1	Content of Reliabilit	Ta=25℃	
No.	Test Item	Content of Test	Test condition
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	60℃ 96H
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	-20℃ 96H
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	50℃ 96H
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	0℃ 96H
5	High Temperature /Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time	40℃ 90% RH 96H
6	Temperature Cycle	Endurance test applying the low and high temperature cycle $-20^{\circ}C \leftarrow \rightarrow 25^{\circ}C \leftarrow \rightarrow 60^{\circ}C \leftarrow \rightarrow 25^{\circ}C$ 30min 5min 30min 5min $\leftarrow 1$ cycle	-20℃/60℃ 10 cycles
7	Vibration Test (package state)	Endurance test applying the vibration during transportation	10Hz~150Hz, 50m/s ² , 40min
8	Shock Test (package state)	Endurance test applying the shock during transportation	Half- sine wave, 100m/s ² , 11ms
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	40kPa 16H

8.1 Content of Reliability Test

8.2 Failure Judgment Criterion

Criterion			T	est	Iter	n N	0.			Esilves Indesenant Criterian
Item	1	2	3	4	5	6	7	8	9	Failure Judgement Criterion
Basic Specification	\checkmark					\checkmark	\checkmark	\checkmark	\checkmark	Out of the basic Specification
Electrical specification										Out of the electrical specification
Mechanical Specification								\checkmark		Out of the mechanical specification
Optical Characteristic									\checkmark	Out of the optical specification
Note	For test item refer to 8.1									
Remark	Basic specification = Optical specification + Mechanical specification									

9 QUALITY LEVEL

Examination	At $T_a=25^{\circ}C$ (unless otherwise stated)	Inspection					
or Test		Min.	Max.	Unit	IL	AQL	
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	See Appendix A			П	Major 1.0 Minor 2.5	
Display Defects	Under normal illumination and eyesight condition, display on inspection. See Appendix B			Π	Major 1.0 Minor 2.5		
Note: Major defects: Open segment or common, Short, Serious damages, Leakage Miner defects: Others Sampling standard conforms to GB2828							

10 Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.

10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : $0^{\circ}\mathbb{C} \sim 40^{\circ}\mathbb{C}$ Relatively humidity: $\leq 80\%$

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Appendix A

Inspection items and criteria for appearance defects

Items	Contents	Criteria				
Protective Glue		No clear defects				
Cover Tape		Covering all of the chip and no clear crimple				
Leakage		Not permitted				
Rainbow		According to the limit specimen				
Wrong polarizer attachment Not permitted						
	Bubble between	Not counted		Max. 3 defects allowed		
Polarizer	polarizer and glass	φ<0.3mm		0.3mm≤φ≤0.5mm		
	Scratches of polarizer	According to the limit specimen				
Black spot		Not counted	Max. 3 spots allowed			
(in viewing area)		X<0.2mm	0.2mm≪X≪0.5mm		Max. 3	
		X=(a+b)/2			spots (lines)	
Black line (in viewing area)	b b	Not counted	Max. 3 lines allowed		allowed	
		a<0.02mm	0.021	mm≪a≪0.05mm b≪2.0mm		
Progressive cracks		Not permitted				

Appendix A

Inspection item and criteria for appearance defects (continued)

Items	Contents	Criteria					
	Cracks on pads	а	b		с	Max. 2	
		≪3mm	≪W/5		≤T/2	cracks	
		≤2mm	≪v	V/5	T/2 <c< T</c< 	allowed	
	Cracks on contact side	a		b		-	
		≤3m	≤ 3 mm $\leq T/2$		≤ T/2		
		≤2m	m]	[/2 <b<t< td=""><td colspan="2"></td></b<t<>		
Glass Cracks		C shall be not reach the seal area				Max. 2 cracks allowed	Max. 5 cracks allowed
	Cracks on non-contact side	a b					
		≪3m	m		≤T/2		
		≤2m	$\leq 2mm$ T/2 <b<t< td=""><td></td><td></td></b<t<>				
		C≤0.5mm					
		d≪SW/3					
	Corner cracks	e<2.0mm ²				Max. 3	
	f-P	f<2.0mm	2			cracks allowed	

Appendix B

Inspection items and criteria for display defects

Items		Contents	Critera			
Open segment or open common		Not permitted				
Short		Not permitted				
Wrong viewing angle		Not permitted				
Contrast radio uneven		According to the limit specimen				
Crosstalk			According to the limit specimen			
			Not counted	Max.3 dots allowed		
			X<0.1mm	0.1mm≤X≤0.2mm		
		X=(a+b)/2		Max.3		
Pin holes and cracks	D				dots allowed	
in segment (DOT)		Not counted	Max.2 dots allowed	anowed		
		A<0.1mm	0.1mm≤A≤0.2mm D<0.25mm			
Black spot (in viewing area)		Not counted	Max.3 spots allowed			
		X<0.1mm	0.1mm≤X≤0.2mm	-		
		X=(a+b)/2		Max.3 spots		
Black line		Not counted	Max.3 lines allowed	(lines) allowed		
(in viewing area)		a<0.02mm	0.02mm≤a≤0.05mm b≤0.5mm			

Appendix B

Inspection items and criteria for display defects (continued)

Items	Content	Critera				
		Not counted	Max. 2 defects allowed			
		x<0.1mm	0.1mm≤x≤0.2mm			
		x=(a+b)/2				
				Max.3 defects		
		Not counted	Max. 1 defects allowed	allowed		
Transfor- mation of segment		a<0.1mm	0.1mm≤a≤0.2mm D>0			
		Max.2 defects 0.8W≤a≤1.2 a=measured va W=nominal va	2W alue of width			